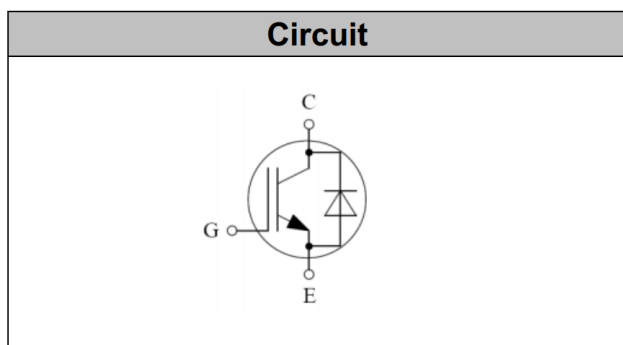


IGBT Discrete

V_{CE}	650	V
I_C	40	A
$V_{CE(SAT)} I_C=40A$	1.6	V

TO-220 Pin Configuration



Applications

- High-frequency converters
- AC and DC servo drive amplifier
- Induction heating

Features

- High breakdown voltage to 650V for improved reliability
- Maximum junction temperature 175°C
- Positive temperature coefficient
- Resonant converters
- Induction heating

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	650	V
DC Collector Current, limited by T_{jmax} $T_C=25^\circ C$ $T_C=100^\circ C$	I_C	69 40	A
Diode Forward Current, limited by T_{jmax} $T_C=25^\circ C$ $T_C=100^\circ C$	I_F	40 25	A
Continuous Gate-Emitter Voltage	V_{GE}	± 20	V
Pulsed Collector Current, $V_{GE}=15V$, t_p limited by T_{jmax}	I_{CM}	160	A
Power Dissipation, $T_j=175^\circ C, T_C=25^\circ C$	P_{tot}	246	W
Operating Junction Temperature	T_j	-40...+175	°C
Storage Temperature	T_s	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm(0.063in.) from case for 10s	-	260	°C

Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT Thermal Resistance, Junction - Case	$R_{th(j-c)}$	0.61	K/W
Diode Thermal Resistance, Junction - Case	$R_{th(j-c)}$	1.64	K/W
Thermal Resistance, Junction - Ambient	$R_{th(j-a)}$	40	K/W

Electrical Characteristics of the IGBT ($T_j = 25^\circ\text{C}$ unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Collector-Emitter Breakdown Voltage	BV_{CES}	$V_{GE}=0V, I_C=250\mu A$	650	-	-	V
Gate Threshold Voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=250\mu A$	4.5	5.5	6.5	V
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=40A$ $T_j=25^\circ\text{C},$ $T_j=150^\circ\text{C}$	- -	1.6 2.1	2.05 -	V
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE}=650V, V_{GE}=0V$ $T_j=25^\circ\text{C},$ $T_j=150^\circ\text{C}$	- -	- -	15 300	μA
Gate-Emitter Leakage Current	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 20V$	-	-	100	nA
Input Capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V,$ $f=1\text{MHz}$	-	1920	-	pF
Output Capacitance	C_{oes}		-	100	-	
Reverse Transfer Capacitance	C_{res}		-	32	-	
Gate Charge	Q_G	$V_{CC}=40V, I_C=40A,$ $V_{GE}=15V$	-	127	-	nC
Gate-Emitter Charge	Q_{GE}		-	15	-	
Gate-Collector Charge	Q_{GC}		-	37	-	

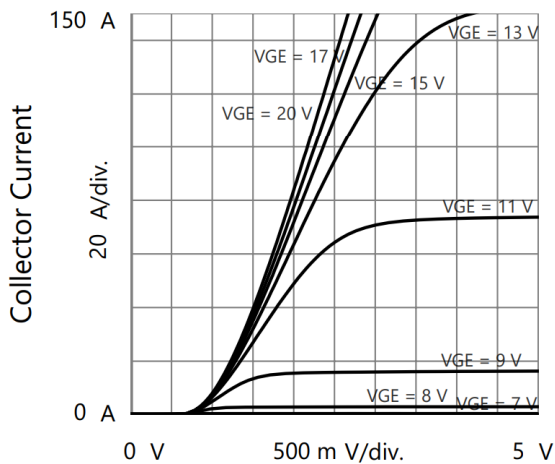
Switching Characteristic, Inductive Load ($T_j = 25^\circ\text{C}$ unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Turn-on Delay Time	$t_{d(on)}$	$V_{CC} = 400\text{V}$, $I_C = 40\text{A}$, $V_{GE} = 15\text{V}$ $R_g = 10\Omega$	-	26	-	ns
Rise Time	t_r		-	35	-	ns
Turn-on Energy	E_{on}		-	1.05	-	mJ
Turn-off Delay Time	$t_{d(off)}$		-	110	-	ns
Fall Time	t_f		-	14	-	ns
Turn-off Energy	E_{off}		-	0.32	-	mJ

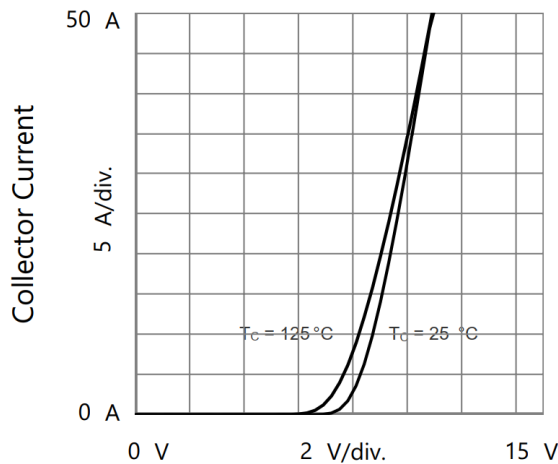
Electrical Characteristics of the DIODE ($T_j = 25^\circ\text{C}$ unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Diode Forward Voltage	V_F	$I_F = 40\text{A}$	-	1.75	-	V
Reverse Recovery Time	T_{rr}	$I_F = 40\text{A}$, $V_R = 400\text{V}$, $di/dt = -100\text{A}/\mu\text{s}$,	-	80	-	ns
Reverse Recovery Charge	Q_{rr}		-	839	-	nC

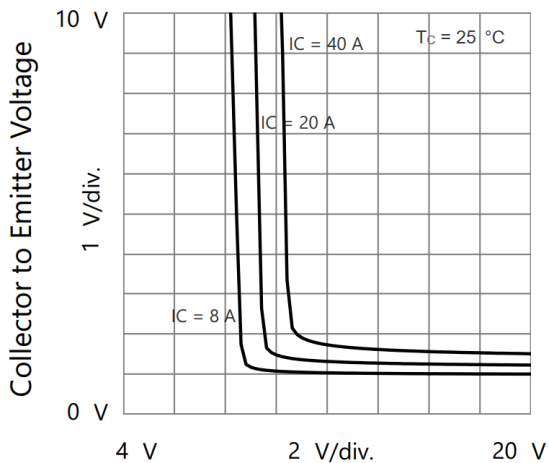
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



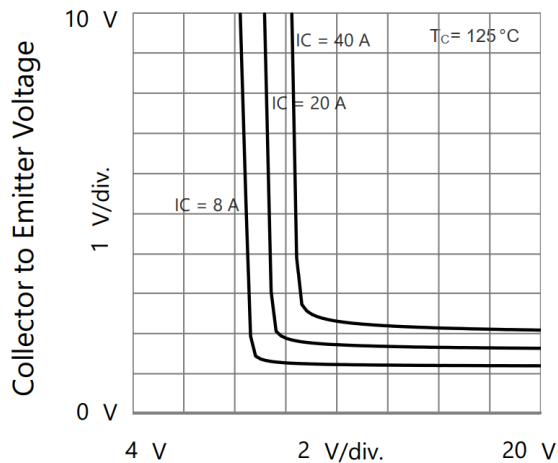
Collector to Emitter Voltage
Output Characteristics



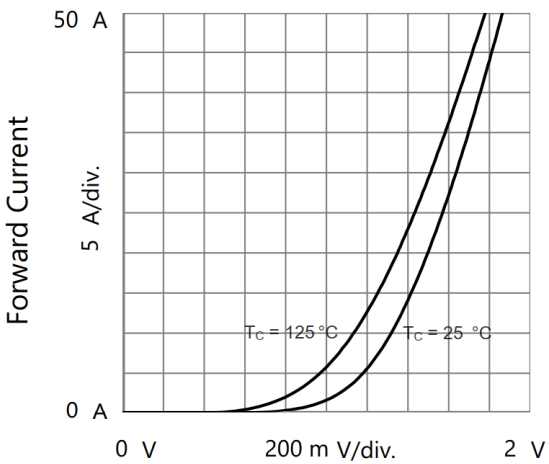
Gate to Emitter Voltage
Transfer Characteristics



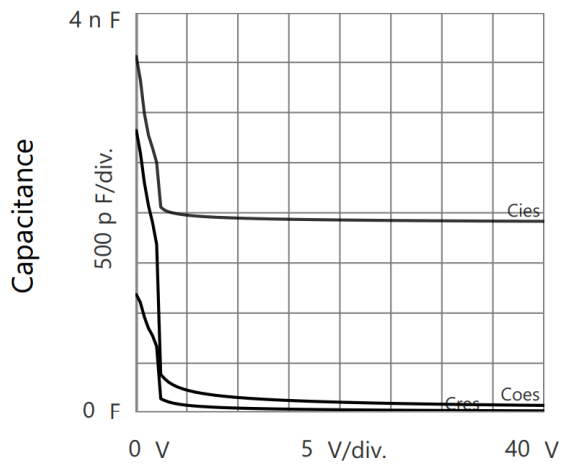
Gate to Emitter Voltage
Collector to Emitter Voltage vs. Gate to Emitter Voltage



Gate to Emitter Voltage
Collector to Emitter Voltage vs. Gate to Emitter Voltage

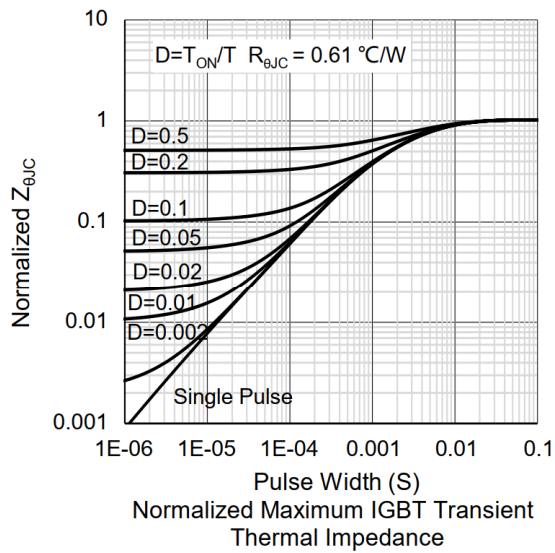
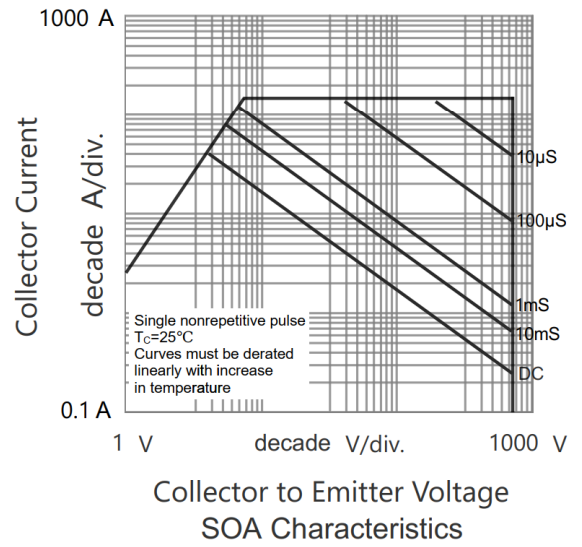
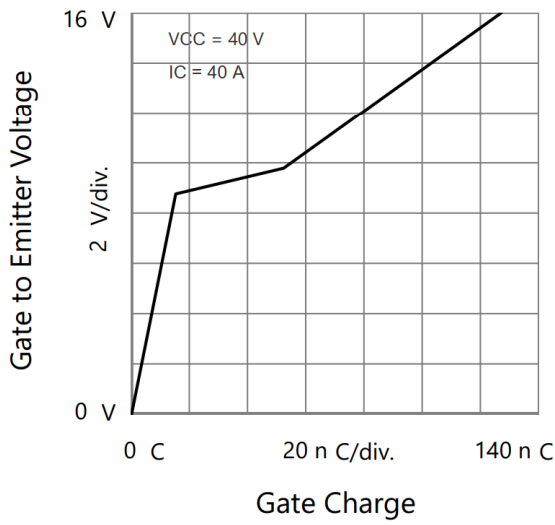


Forward Voltage
Freewheeling Diode Forward Characteristics

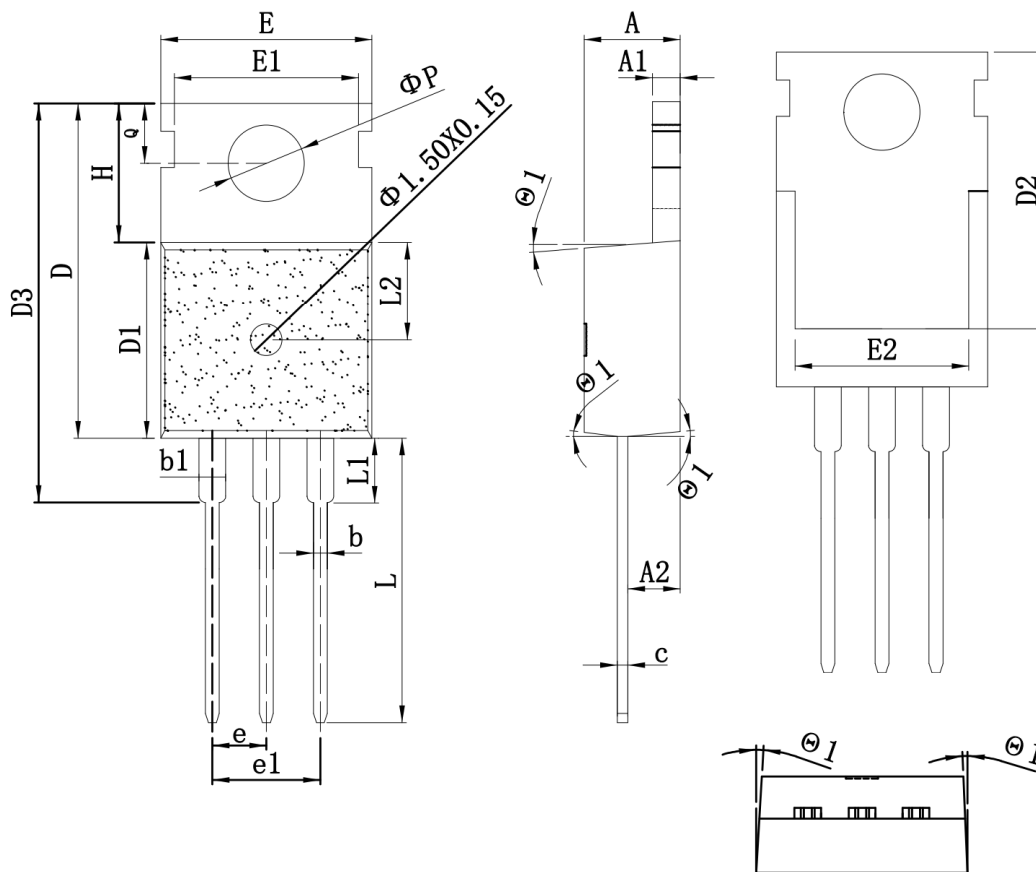


Collector to Emitter Voltage
Capacitances

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



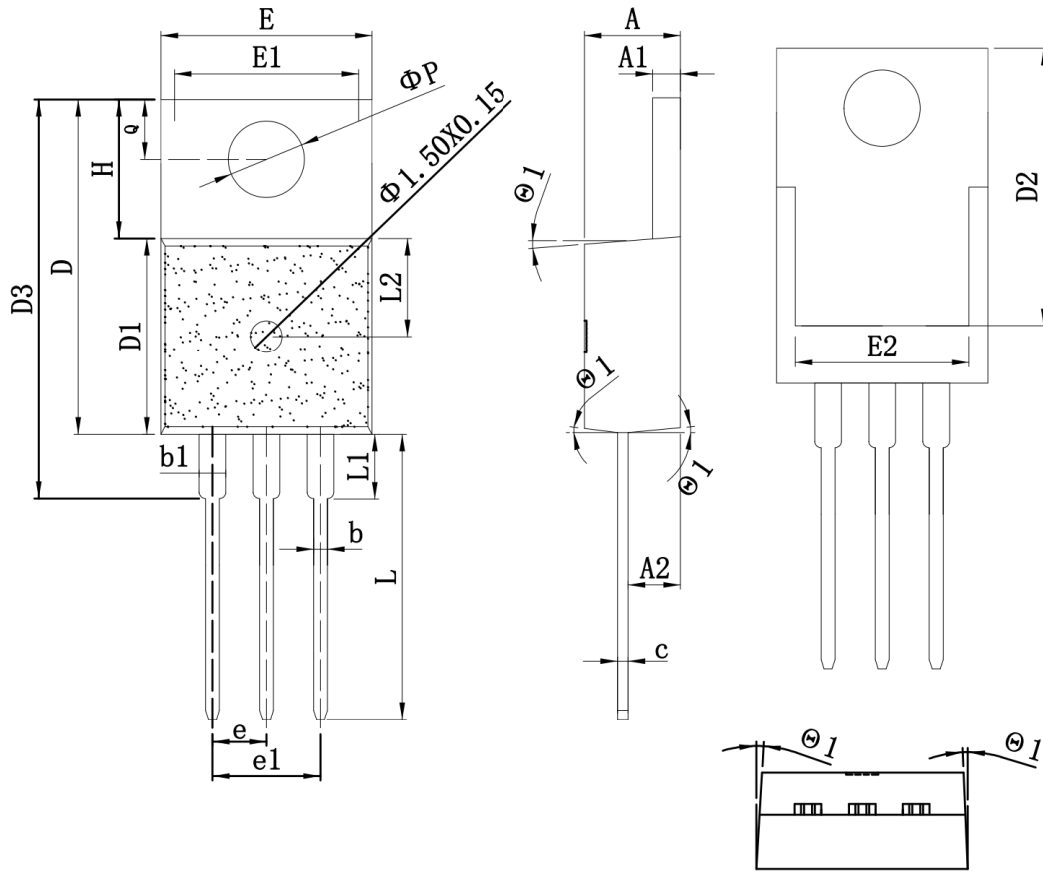
TO-220_3L-A PACKAGE OUTLINE



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	mm			SYMBOL	mm		
	MIN	TYP	MAX		MIN	TYP	MAX
A	4.15	4.50	4.80	E1	8.25	8.70	9.15
A1	1.15	1.30	1.50	E2	7.20	8.00	8.80
A2	2.10	2.40	2.65	e	2.38	2.54	2.74
b	0.65	0.80	1.00	e1	5.08REF		
b1	1.10	1.33	1.80	H	6.20	6.50	6.90
c	0.35	0.50	0.65	L	12.75	13.28	13.70
D	14.25	15.75	16.15	L1	-	-	3.50
D1	8.70	9.20	9.60	L2	2.30	4.65	7.00
D2	12.30	13.10	13.85	ϕP	3.40	3.65	3.85
D3	16.20	18.80	20.60	Q	2.50	2.80	3.00
E	8.68	10.02	11.00	θ	2°	-	7°

TO-220_3L-B PACKAGE OUTLINE



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	mm			SYMBOL	mm		
	MIN	TYP	MAX		MIN	TYP	MAX
A	4.15	4.50	4.80	E1	8.25	8.70	9.15
A1	1.15	1.30	1.50	E2	7.20	8.00	8.80
A2	2.10	2.40	2.65	e	2.38	2.54	2.74
b	0.65	0.80	1.00	e1	5.08REF		
b1	1.10	1.33	1.80	H	6.20	6.50	6.90
c	0.35	0.50	0.65	L	12.75	13.28	13.70
D	14.25	15.75	16.15	L1	-	-	3.50
D1	8.70	9.20	9.60	L2	2.30	4.65	7.00
D2	12.30	13.10	13.85	ϕP	3.40	3.65	3.85
D3	16.20	18.80	20.60	Q	2.50	2.80	3.00
E	8.68	10.02	11.00	θ	2°	-	7°

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